

# PolarHV<sup>™</sup> HiPerFET Power MOSFET

IXFH 24N80P IXFK 24N80P IXFT 24N80P

 $V_{DSS} = 800$  V  $I_{D25} = 24$  A  $R_{DS(on)} \le 400$  mΩ  $t_{rr} \le 250$  ns

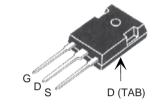
N-Channel Enhancement Mode Avalanche Rated Fast Intrinsic Diode



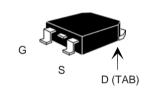
Symbol	Test Conditions	Maximum	Ratings
V <sub>DSS</sub> V <sub>DGR</sub>	$T_J = 25^{\circ}\text{C}$ to $150^{\circ}\text{C}$ $T_J = 25^{\circ}\text{C}$ to $150^{\circ}\text{C}$ ; $R_{GS} = 1 \text{ M}\Omega$	800 800	V
$V_{\rm gss}$	Continuous	±30	V
V <sub>GSM</sub>	Transient	±40	V
I <sub>D25</sub>	$T_c = 25^{\circ}C$	24	Α
I <sub>DM</sub>	$\rm T_{_{\rm C}}$ = 25°C, pulse width limited by $\rm T_{_{\rm JM}}$	55	Α
I <sub>AR</sub>	$T_c = 25^{\circ}C$	12	А
$\mathbf{E}_{AR}$	$T_{c} = 25^{\circ}C$	50	mJ
E <sub>AS</sub>	$T_c = 25^{\circ}C$	1.5	J
dv/dt	$\begin{split} &I_{_{S}} &\leq I_{_{DM}}, \text{ di/dt} \leq 100 \text{ A/}\mu\text{s}, \text{ V}_{_{DD}} \leq \text{V}_{_{DSS}}, \\ &T_{_{J}} &\leq 150^{\circ}\text{C}, \text{ R}_{_{G}} = 2 \Omega \end{split}$	10	V/ns
$P_{D}$	T <sub>c</sub> = 25°C	650	W
T <sub>J</sub> T <sub>JM</sub> T <sub>stg</sub>		-55 +150 150 -55 +150	°C °C °C
$\mathbf{M}_{\mathbf{d}}$	Mounting torque (TO-247 & TO-264)	1.13/10	Nm/lb.in.
Weight	TO-247 TO-268 TO-264	6 5 10	g g
T <sub>L</sub> T <sub>SOLD</sub>	1.6 mm (0.062 in.) from case for 10 s Plastic body for 10 s	300 260	°C °C

<b>Symbol</b> (T <sub>J</sub> = 25°C, t	Test Conditions unless otherwise specified)		Ch Min.	istic Val	
BV <sub>DSS</sub>	$V_{GS} = 0 \text{ V}, I_{D} = 250  \mu\text{A}$		800		V
V <sub>GS(th)</sub>	$V_{DS} = V_{GS}, I_{D} = 4 \text{ mA}$		3.0	5.0	V
I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA
I <sub>DSS</sub>	$V_{DS} = V_{DSS}$ $V_{GS} = 0 V$	T <sub>J</sub> = 125°C		25 1000	μA μA
R <sub>DS(on)</sub>	$V_{GS} = 10 \text{ V}, I_D = 0.5 I_{D25}$ Pulse test, t \le 300 \mus, duty 0	cycle d ≤2%		400	mΩ

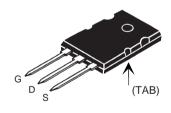




TO-268 (IXFT) Case Style



## TO-264 AA (IXFK)



G = Gate D = DrainS = Source Tab = Drain

### **Features**

- International standard packages
- Fast recovery diode
- Unclamped Inductive Switching (UIS) rated
- Low package inductance
  - easy to drive and to protect

### **Advantages**

- Easy to mount
- Space savings
- High power density

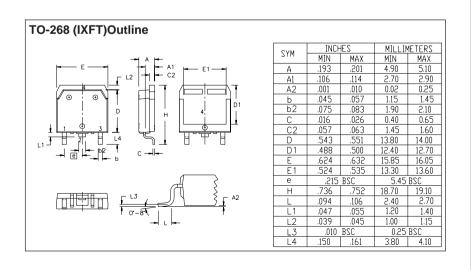


#### **Test Conditions Characteristic Values Symbol** (T<sub>1</sub> = 25°C, unless otherwise specified) Min. Typ. | Max. 15 S $V_{DS} = 20 \text{ V}; I_{D} = 0.5 I_{D25}, \text{ pulse test}$ 25 $g_{fs}$ рF Ciss 7200 $V_{GS} = 0 \text{ V}, V_{DS} = 25 \text{ V}, f = 1 \text{ MHz}$ $\mathbf{C}_{\mathrm{oss}}$ 470 pF C<sub>rss</sub> 26 pF $\mathbf{t}_{\text{d(on)}}$ 32 ns $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ I}_{D25}$ t, 27 ns $R_c = 2 \Omega \text{ (External)}$ 75 $\mathbf{t}_{\mathsf{d(off)}}$ ns 24 ns t, Q<sub>g(on)</sub> 105 nC $\mathbf{Q}_{\mathrm{gs}}$ $V_{GS} = 10 \text{ V}, V_{DS} = 0.5 \text{ V}_{DSS}, I_{D} = 0.5 \text{ I}_{D25}$ 30 nC $\mathbf{Q}_{\mathrm{gd}}$ 33 nC ${\rm R}_{\rm thJC}$ 0.19 °C/W $\mathbf{R}_{\text{thCS}}$ TO-247 0.21 °C/W $R_{\text{thCS}}^{\text{``}}$ TO-264 0.15 °C/W

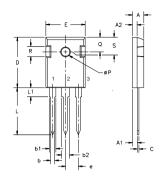
### Source-Drain Diode

Characteristic Values (T, = 25°C, unless otherwise specified)

Symb	ol Test Condition	ns N	/lin.	Тур.	Max.	-
I <sub>s</sub>	V <sub>GS</sub> = 0 V				24	A
I <sub>SM</sub>	Repetitive				55	Α
V <sub>SD</sub>	$I_F = I_S$ , $V_{GS} = 0$ Pulse test, $t \le$	V, 300 μs, duty cycle d≤2 %			1.5	V
t <sub>rr</sub>	$I_F = 25A, -di/dt$	t = 100 A/μs			250	ns
$\mathbf{Q}_{_{\mathbf{R}\mathbf{M}}}$	$ V_R = 100V$			0.8 6.0		μC Α

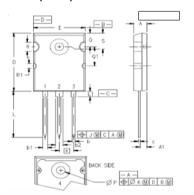


# TO-247 AD (IXFH) Outline



Dim.	Millimeter		Inc	hes	
	Min.	Max.	Min.	Max.	
Α	4.7	5.3	.185	.209	
A,	2.2	2.54	.087	.102	
A <sub>2</sub>	2.2	2.6	.059	.098	
b	1.0	1.4	.040	.055	
b <sub>1</sub>	1.65	2.13	.065	.084	
b <sub>2</sub>	2.87	3.12	.113	.123	
С	.4	.8	.016	.031	
D	20.80	21.46	.819	.845	
E	15.75	16.26	.610	.640	
е	5.20	5.72	0.205	0.225	
L	19.81	20.32	.780	.800	
L1		4.50		.177	
ØP	3.55	3.65	.140	.144	
Q	5.89	6.40	0.232	0.252	
R	4.32	5.49	.170	.216	
S	6.15	BSC	242	BSC	

### TO-264 (IXFK) Outline



1 - GATE 2, 4 - DRAIN (COLLECTOR) 3 - SOURCE (EMITTER)

SYM	INCHES		MILLIMETERS			
SIM	MIN	MAX	MIN	MAX		
A	.185	.209	4.70	5.31		
A1	.102	.118	2.59	3.00		
b	.037	.055	0.94	1.40		
b1	.087	.102	2.21	2.59		
b2	.110	.126	2.79	3.20		
С	.017	.029	0.43	0.74		
D	1.007	1.047	25.58	26.59		
E	.760	.799	19.30	20.29		
e	.215	BSC	5.46	BSC		
J	.000	.010	0.00	0.25		
K	.000	.010	0.00	0.25		
L	.779	.842	19.79	21.39		
L1	.087	.102	2.21	2.59		
ØP	.122	.138	3.10	3.51		
Q	.240	.256	6.10	6.50		
Q1	.330	.346	8.38	8.79		
ØR	.155	.187	3.94	4.75		
ØR1	.085	.093	2.16	2.36		
S	.243	.253	6.17	6.43		

IXYS reserves the right to change limits, test conditions, and dimensions.



Fig. 1. Output Characteristics @ 25°C

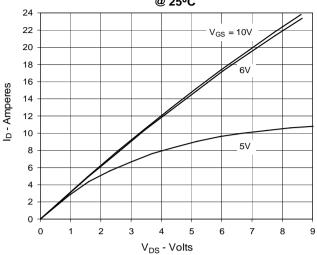


Fig. 2. Extended Output Characteristics

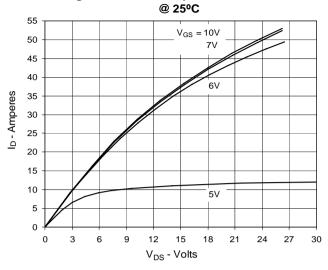


Fig. 3. Output Characteristics @ 125°C

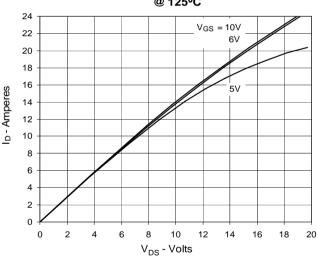


Fig. 4.  $R_{DS(on)}$  Normalized to  $I_D$  = 12A Value vs. Junction Temperature

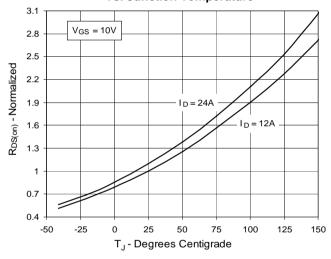


Fig. 5. R<sub>DS(on)</sub> Normalized to I<sub>D</sub> = 12A Value vs. Drain Current

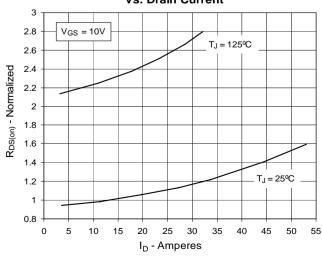
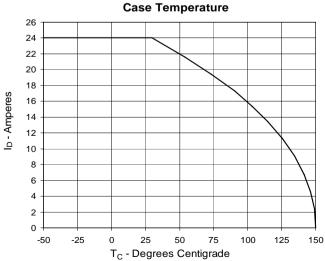


Fig. 6. Maximum Drain Current vs.





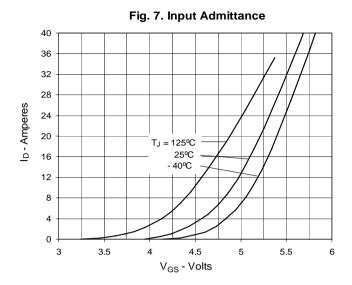
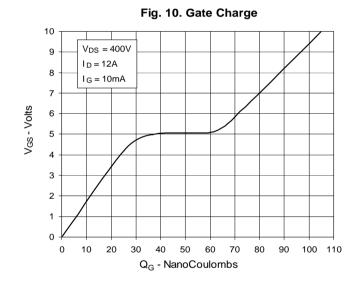
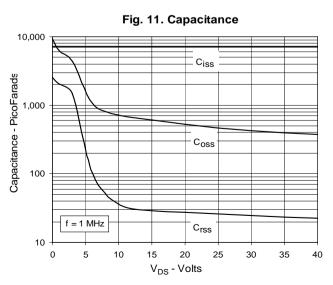
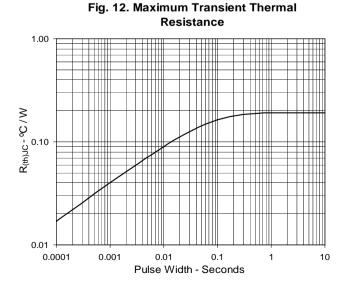


Fig. 8. Transconductance gfs-Siemens  $T_{J} = -40^{\circ}C$ 25℃ I<sub>D</sub> - Amperes

Fig. 9. Forward Voltage Drop of **Intrinsic Diode** T<sub>J</sub> = 125°C  $T_J = 25^{\circ}C$ 0.3 0.4 0.5 0.6 0.7 8.0 0.9 V<sub>SD</sub> - Volts







IXYS reserves the right to change limits, test conditions, and dimensions.

